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09-20-2002



U.S. DEPARTMENT OF COMMERCE

SON-2403

10,	ZZZOZII Patent and Trademark Office
To the Honorable Commissioner of Patents and Trademarks: Please rec	cord the attached original documents or copy thereof.
Name of conveying party(ies)	2. Name and address of receiving party(ies)
(1) Satoshi NAKADA (2) Kazuyuki EJIMA	Name: SONY CORPORATION
(3) Hiroshi MORI	Internal Address:
Additional name(s) of conveying party(ies) attached No.	
3. Nature of conveyance:	Street Address: 7-35 KITASHINAGAWA 6-CHOME SHINAGAWA-KU
⊠ Assignment □ Merger	City: TOKYO, JAPAN
☐ Security Agreement ☐ Change of Name	Additional name(s) & address(es) attached ☐ Yes ☒ No
Execution Date: (1) 8/27/02 (2) 9/2/02 (3) 9/3/02	
4. Application number(s) or patent number(s):10/167,396	
If the document is being filed together with a new application, the ex- Additional numbers attached No.	••
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1
Name: Ronald P. Kananen, Esq.	7. Total fee (37 CFR 3.41)\$ 40.00
Internal Address: RADER, FISHMAN & GRAUER	☐ Enclosed
Suite 501	☑Authorized to be charged to Deposit Account
Street Address: 1233 20 th Street, NW	8. Deposit account number:
City: Washington, D.C. Zip: 20036	18-0013 (Attach duplicate copy of this page if paying by deposit account)
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document.	s true and correct and any attached copy is a true copy of the original
Ronald P. Kananen Name of Person Signing Signature	September 12, 2002 Date
Total number of pages comprising cover sheet 1	Date
P V	
19/2002 GTON11 00000106 180013 10167396	
FC:581 40.00 CH	

PATENT REEL: 013296 FRAME: 0274

Docket	Number	SON-2403	
DUCKEL	iyumper.		

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in PLASMA DISPLAY DEVICE AND METHOD OF PRODUCING THE SAME

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 10/167,396, Filing Date: June 13, 2002.

This assignment executed on the dates indicated below.

SATOSHI NAKADA

Name of first or sole inventor

Execution date of U.S. Patent Application

KANAGAWA, JAPAN

Residence of first or sole inventor

August 27, 2002

70000-700

Date of this assignment

KAZUYUKI EJIMA	
Name of second inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of second inventor	
Karnetiki Giina	Sep. 2. 2002
Kazurfuki Gjuna Signature of second inventor	Sep. 2. 2002. Date of this assignment
HIROSHI MORI	
Name of third inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of third inventor	
Hyrochi Mari	Sep. 3. 2002. Date of this assignment
HMoslu Mori Signature of third inventor	Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
	••
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

RECORDED: 09/12/2002

PATENT REEL: 013296 FRAME: 0276